## **EAST Search History**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2926	257/678.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/28 12:01
S1	442	CSP and (tape near2 substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/28 09:39
S2	524	CSP and (tape near2 substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/28 10:13
S3	1469	257/780.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/28 11:56
S4	2334	257/737.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/28 10:52
S5	1997	257/738.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/28 12:01
S6	1332	257/701.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/09/28 11:27
S7	510	257/702.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/28 11:43
S8	140	((chip die) and bump and interconnect\$3 and terminal).clm.	US-PGPUB	OR	ON	2006/09/28 11:44
S9	32	((chip die) and bump and interconnect\$3 and terminal and adhesive).clm.	US-PGPUB	OR	ON	2006/09/28 11:44



## **EAST Search History**

S10	3889	257/758.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2006/09/28 11:56
			IBM_TDB			

